



“I-V Characteristics of a Static Random Access Memory Cell Utilizing Ferroelectric Transistors”

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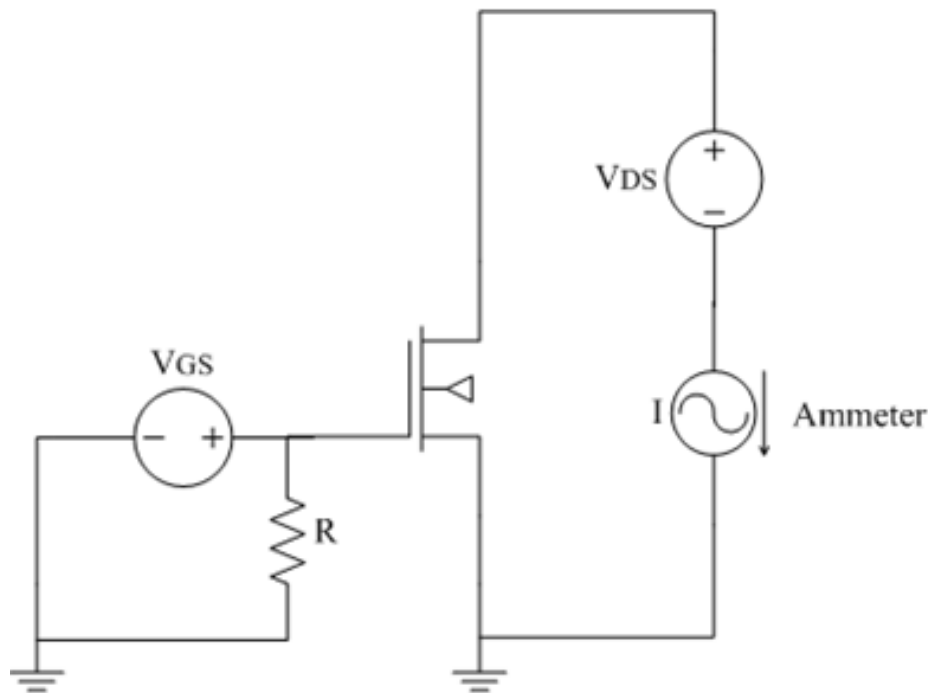
Introduction

- SRAM utilizing Ferroelectric FETs may make high speed memory possible with significant retention times without power (Retention times of 24 hours have been measured)
- Ferroelectric Field-Effect Transistor features polarization due to the ferroelectric layer between the substrate and the gate.
- After removal of the applied input voltage, the polarization still exists, thus the FeFET features unique I-V characteristics
- Current-Voltage (I-V) Characteristics Presented
 - FeFET
 - Resistive Load Static Random Access Memory (SRAM) Cell
- I-V FeFET Model Developed
- Comparison
 - Metal-Oxide-Semiconductor Field Effect Transistor (MOSFET) and FeFET

FeFET Properties

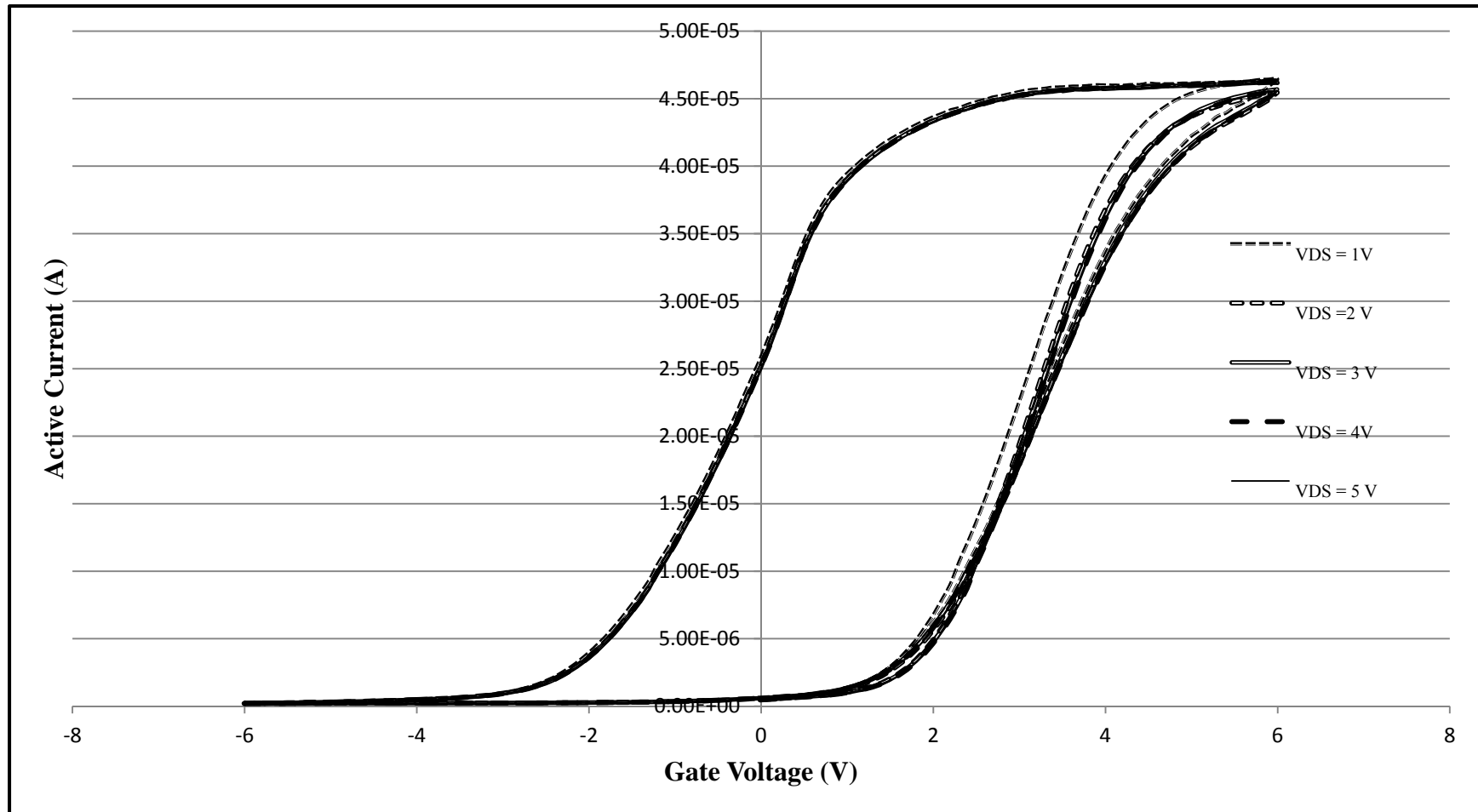
- Ferroelectrics feature properties including
 - Polarization
 - Positive and Negative
 - Hysteresis
 - History dependence
 - Nonlinearity
- The ferroelectric layer gives FeFET unique I-V characteristics
 - Unlike the MOSFET, the I-V characteristics feature a hysteresis trend

FeFET I-V Characterization

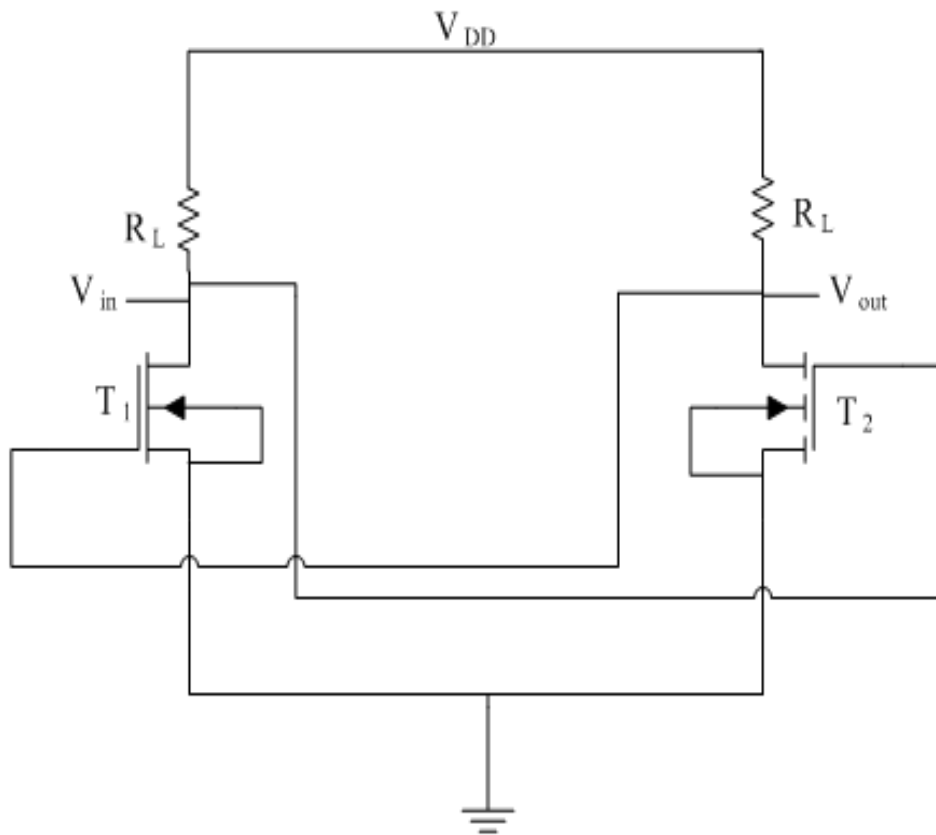


- Ferroelectric Transistor was $10\ \mu\text{m}$ wide and $10\ \mu\text{m}$ long, provided by Radiant Technologies Inc.
- FeFET featured a PZT ferroelectric layer
- FeFET active current was measured with test circuit, shown left
- PZT ferroelectric layer was properly polarized
- The drain-to-source voltage (V_{DS}) was varied for a range of gate-to-source voltages (V_{GS}) and the drain current was measured

ND1 Active Current for Various V_{DS}

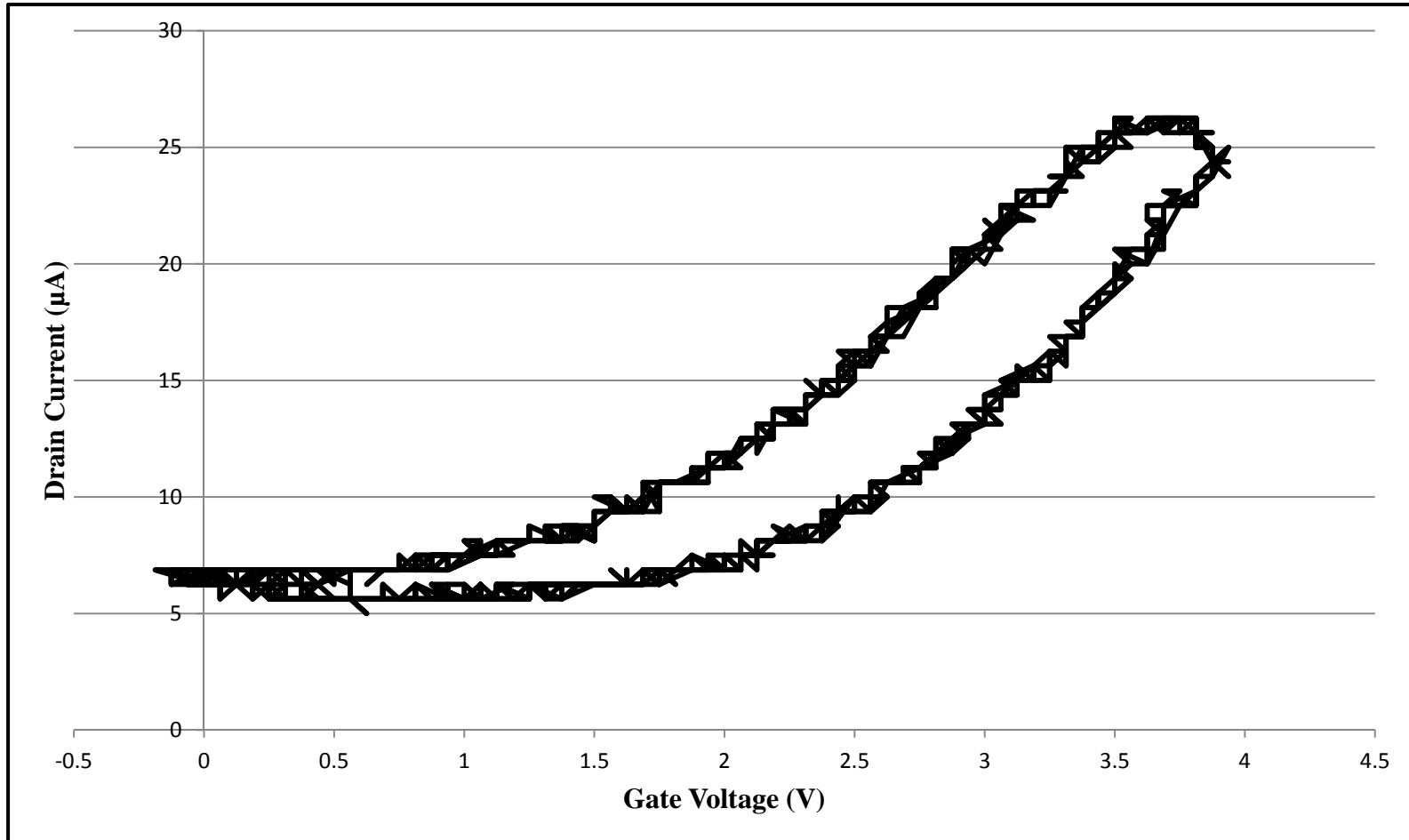


SRAM Cell Operation

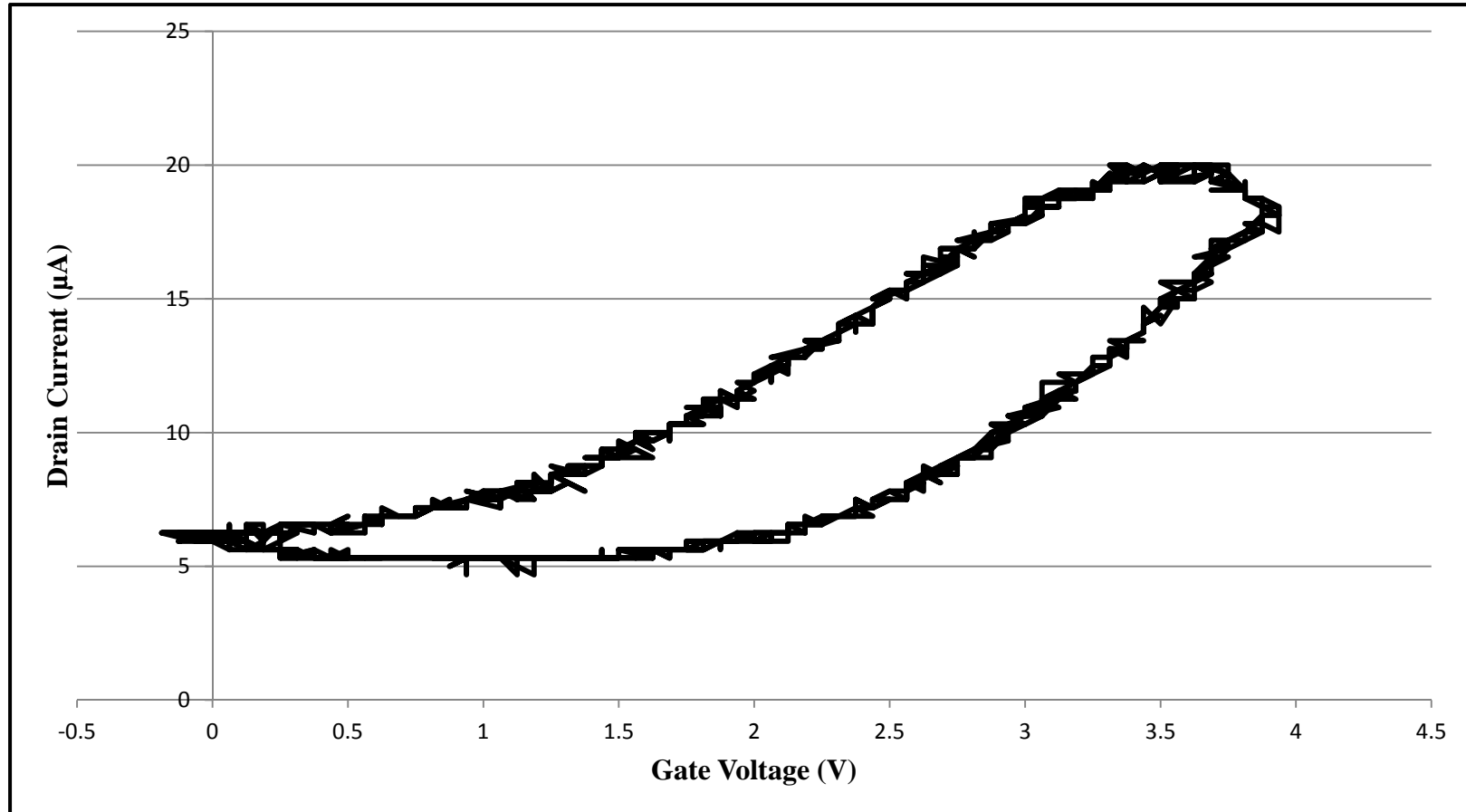


- A traditional resistive load SRAM cell was constructed as shown on the left
- The input voltage, V_{in} , is applied at drain of T_1 and the output voltage, V_{out} , is read at drain of T_2
- A couple different configurations were investigated
 - FeFETs for T_1 and T_2
 - Various resistance values with FeFETs for T_1 and T_2

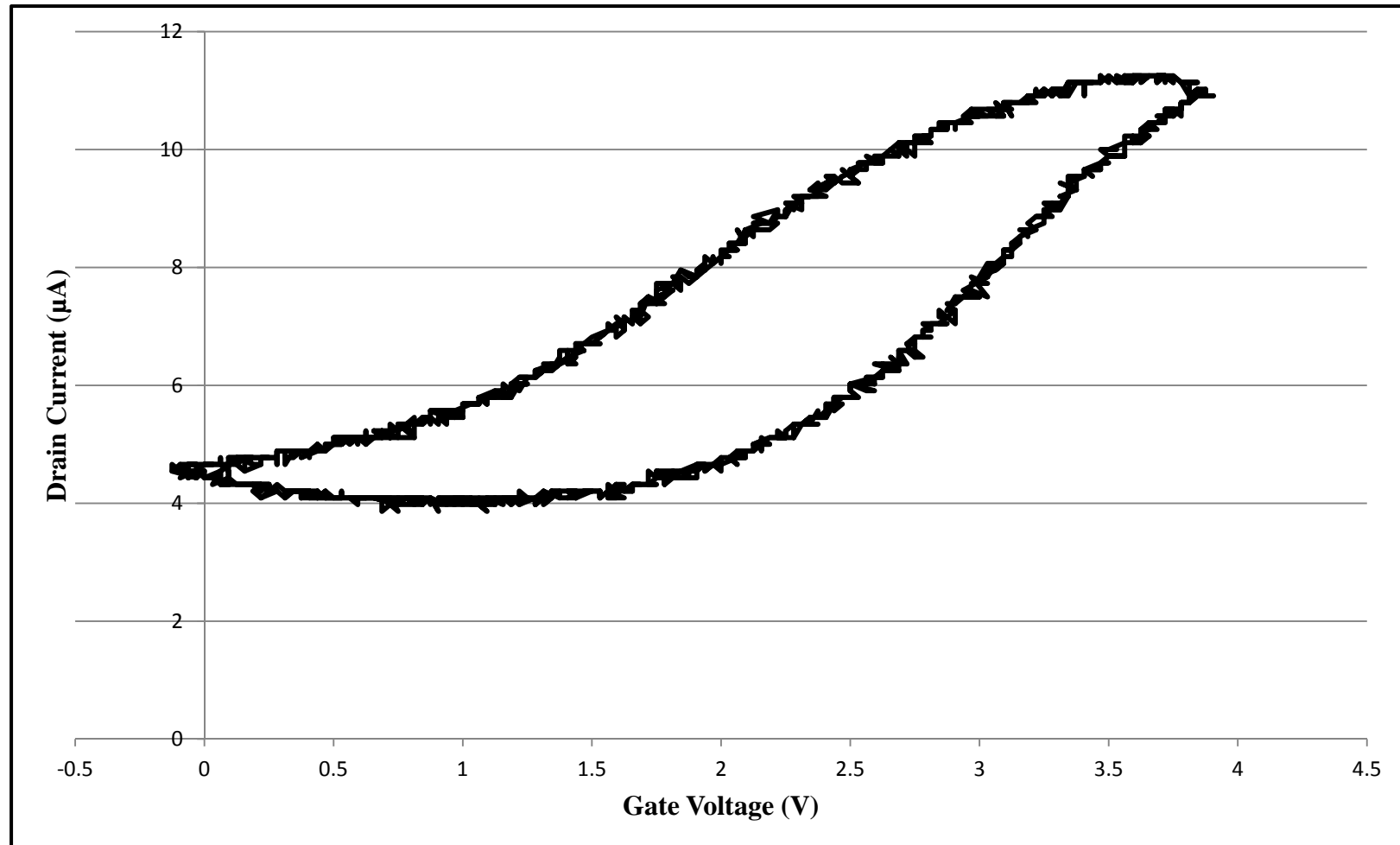
ND1 SRAM I-V Characteristics at a Load Resistance of 51 k Ω



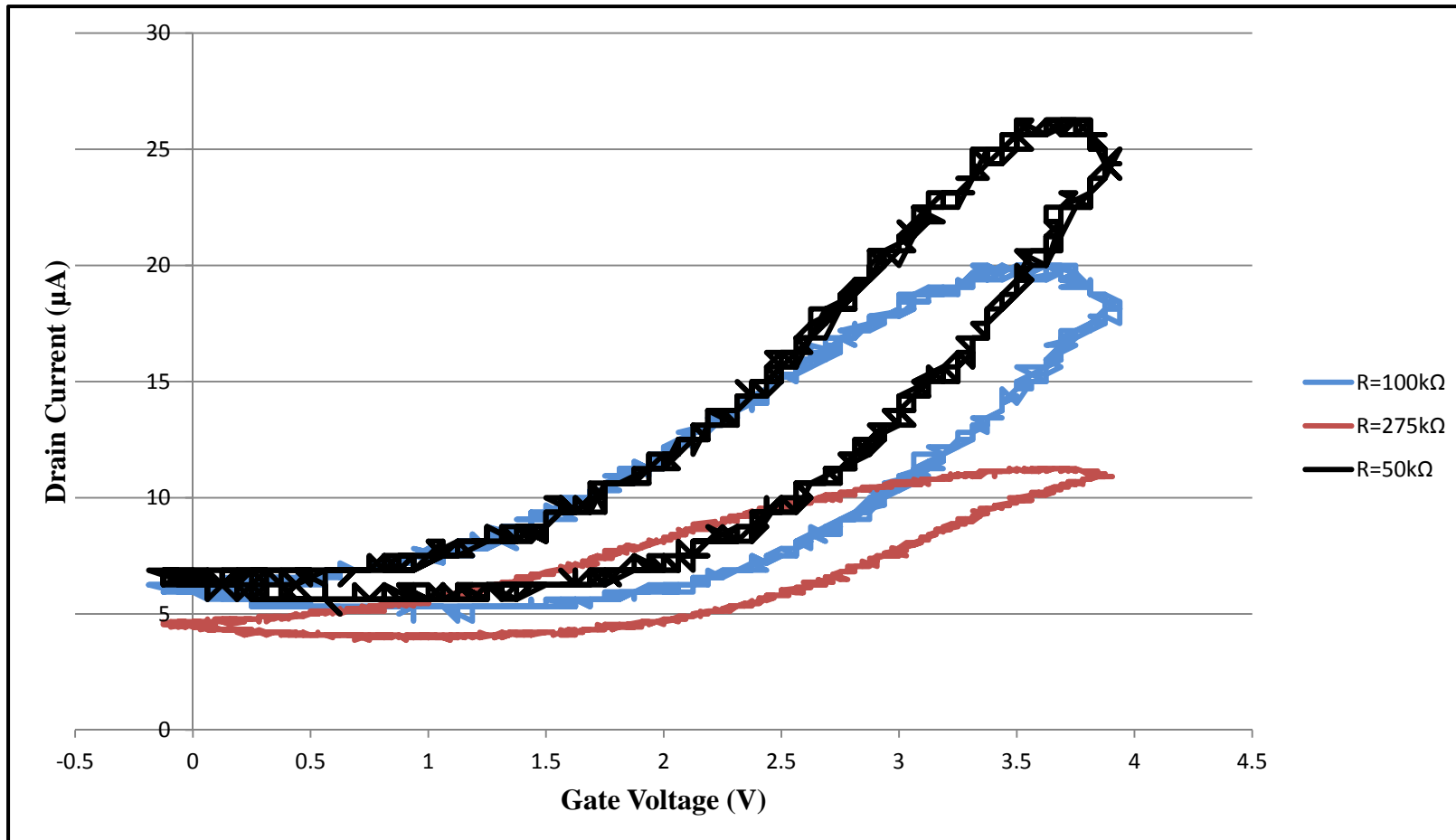
ND1 SRAM I-V Characteristics at a Load Resistance of 105 k Ω



ND1 SRAM I-V Characteristics at a Load Resistance of 275 k Ω



ND1 SRAM I-V Comparison Chart



Conclusion

- I-V characteristics for FeFET different than that of MOSFET
 - Ferroelectric layer features hysteresis trend whereas MOSFET behaves same for both increasing and decreasing V_{GS}
 - FeFET I-V characteristics doesn't show dependence on V_{DS}
- A Transistor with different channel length and width as well as various resistance and input voltages give different results
 - As resistance values increased, the magnitude of the drain current decreased

References

1. C. Mitchell, C. L. McCartney, T. C. MacLeod, F. D. Ho, Characteristics of a Nonvolatile SRAM Cell Utilizing a Ferroelectric Transistor, *Integrated Ferroelectrics*, 132, 82-87 (2012).
2. A. K. Singh, *Digital VLSI Design*, New Delhi: Prentice Hall of India, 2011.
3. S. Kang and Y. Leblebici, *CMOS Digital Integrated Circuits: Analysis and Design*, New York: McGraw Hill, 2003.
4. A. Pittet and A. Kandaswamy, *Analog Electronics*, New Delhi: Prentice Hall of India, 2005.
5. J. Evans, *Modeling Radiant Thin Ferroelectric Film Transistors*, Radiant Technologies Inc, 2011.
6. T. C. MacLeod and F. D. Ho, I-V Characteristics of a Ferroelectric Field-Effect Transistor, *Integrated Ferroelectrics*, **34**, 21-26 (2001).
7. Giuseppe Grosso and Giuseppe Pastori Parravicini, "*Solid State Physics*", 2nd ed. San Diego: Academic Press, 2000.
8. T. A. Phillips, T. C. MacLeod, F. D. Ho, Modeling of a Ferroelectric Field-Effect Transistor Static Random Access Memory Cell. *Integrated Ferroelectrics* **96**, 69-74 (2008).

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